

FEATURES

- $R_{DS(ON)} < 2.4\Omega$ @ $V_{GS}=10V$
- Fast switching capability
- Lead free in compliance with EU RoHS directive.
- Green molding compound

MECHANICAL DATA

- Case: TO-220, ITO-220, TO-251, TO-252, TO-262, TO-263 Package

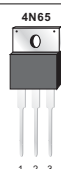
Ordering Information

Part No.	Package	Packing
4N65-TU	TO-220	50pcs / Tube
4N65F-TU	ITO-220	50pcs / Tube
4N65E-TU	TO-262	50pcs / Tube
4N65D-TU	TO-263	50pcs / Tube
4N65D-TR	TO-263	800pcs / 13"Reel
4N65N-TU	TO-251	75pcs / Tube
4N65M-TU	TO-252	75pcs / Tube
4N65M-TR	TO-252	2.5Kpcs / 13"Reel

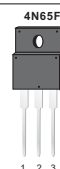
PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
650	2.4 @ $V_{GS}=10V$	4

TO-220AB



ITO-220AB



TO-263



TO-262



TO-251



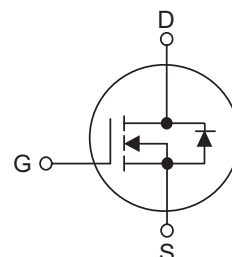
TO-252



Block Diagram

Pin Definition:

1. Gate
2. Drain
3. Source



ABSOLUTE MAXIMUM RATINGS ($T_C=25\text{ C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	650	V
Gate-Source Voltage	V_{GSS}	± 30	V
Continuous Drain Current	I_D	4.0	A
Pulsed Drain Current (Note 2)	I_{DM}	16	A
Avalanche Energy	E_{AS}	260	mJ
Power Dissipation	TO-220/TO-263/TO-262	106	W
	ITO-220	35	
	TO-251/TO-252	50	
Junction Temperature	T_J	+150	C
Storage Temperature	T_{STG}	-55 ~ +150	C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. $L=30\text{mH}$, $I_{AS}=3.6\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25\text{ C}$

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650V N-Channel Power MOSFET

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/ITO-220 TO-262/TO-263	θ_{JA}	62.5	C/W
	TO-251/TO-252		110	
	TO-220/TO-263/TO-262		2.35	
Junction to Case	ITO-220	θ_{JC}	5.5	C/W
	TO-251/TO-252		2.9	

ELECTRICAL CHARACTERISTICS (T_C=25 C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	μA
Gate- Source Leakage Current	Forward	I _{GSS}	V _G =30V, V _{DS} =0V			100	nA
	Reverse		V _G =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =2.0A		2.0	2.4	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1MHz		300		pF
Output Capacitance		C _{OSS}			45		pF
Reverse Transfer Capacitance		C _{RSS}			2		pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time		t _{D(ON)}	V _{DD} =325V, I _D =4.0A, R _G =25Ω (Note 1, 2)		45		ns
Turn-On Rise Time		t _R			100		ns
Turn-Off Delay Time		t _{D(OFF)}			200		ns
Turn-Off Fall Time		t _F			130		ns
Total Gate Charge		Q _G			100		nC
Gate-Source Charge		Q _{GS}	V _{DS} =520V, I _D =4.0A, V _{GS} =10V (Note 1, 2)		17		nC
Gate-Drain Charge		Q _{GD}			20		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} =0V, I _S =4A			1.4	V
Maximum Continuous Drain-Source Diode Forward Current		I _S				4.0	A
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}				16	A
Reverse Recovery Time		t _{rr}	V _{GS} =0V, I _S =4A		260		ns
Reverse Recovery Charge		Q _{RR}	di/dt=100A/μs (Note 1)		2.5		μC

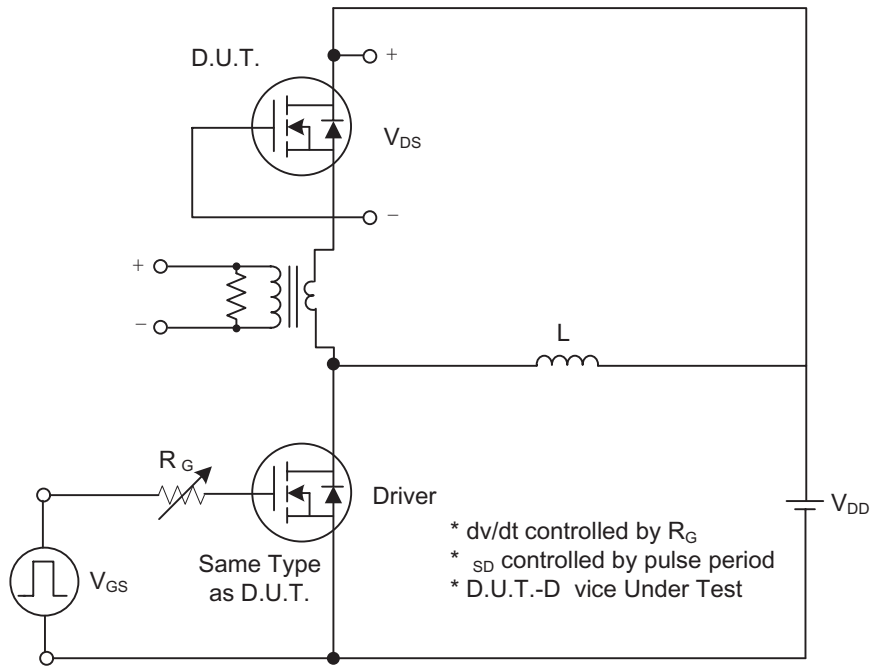
Notes: 1. Pulse Test: Pulse width ≤300μs, Duty cycle ≤2%.

2. Essentially independent of operating temperature.

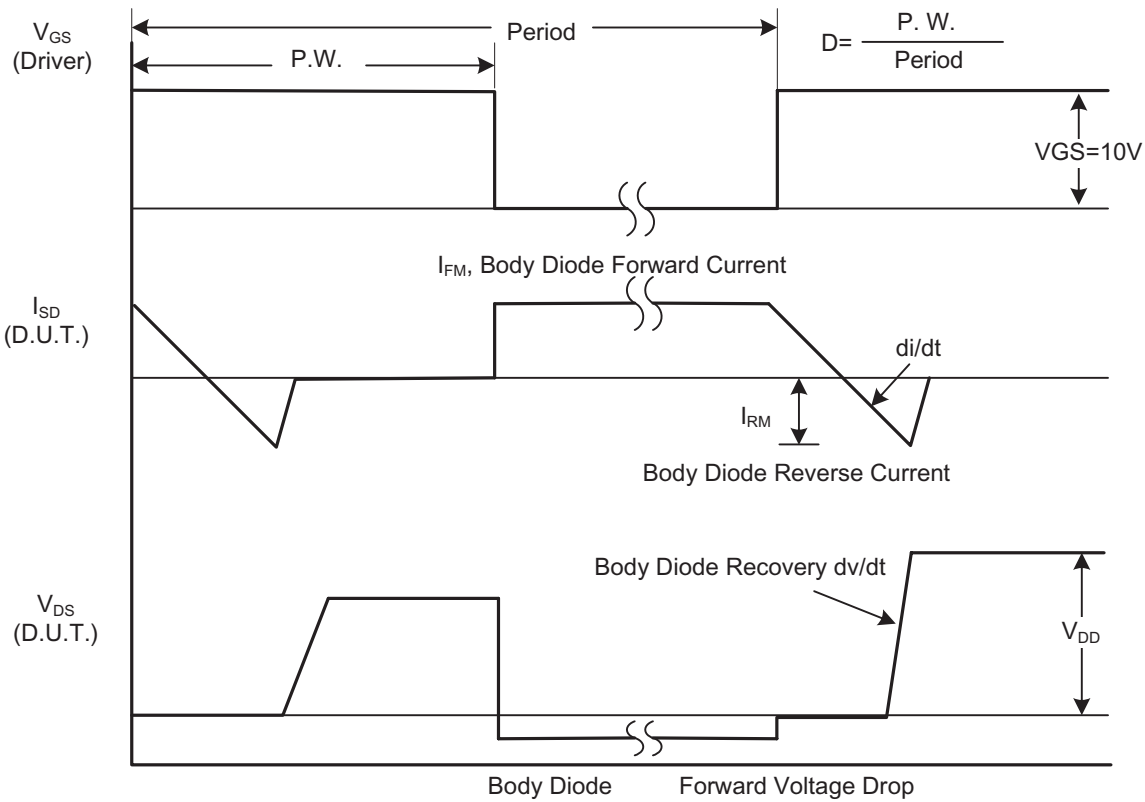
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650V N-Channel Power MOSFET

TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit

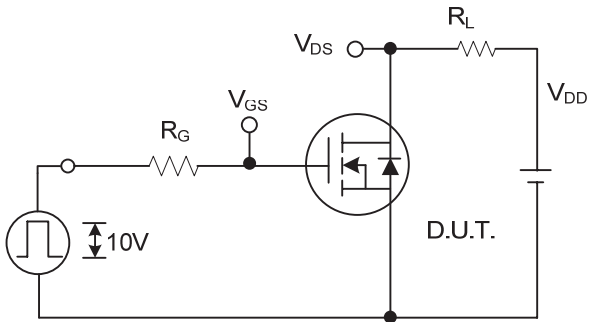


Peak Diode Recovery dv/dt Waveforms

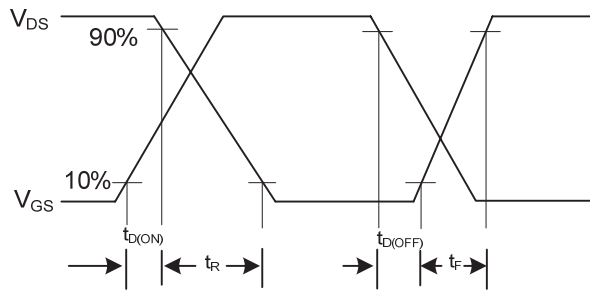
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650V N-Channel Power MOSFET

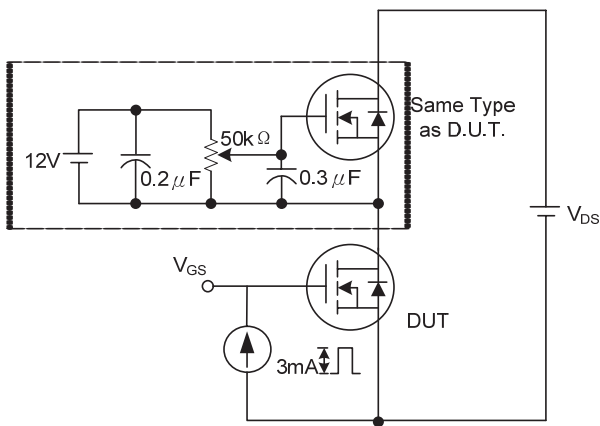
TEST CIRCUITS AND WAVEFORMS(Cont.)



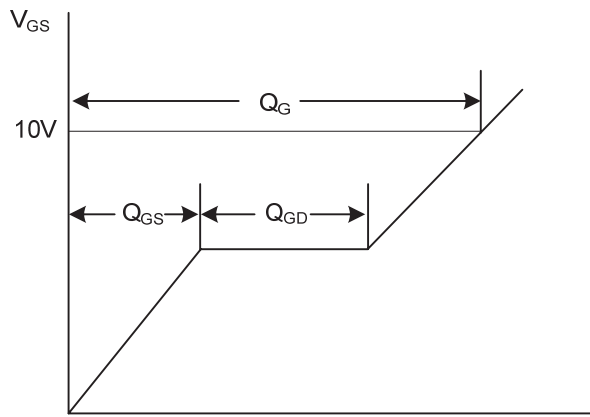
Switching Test Circuit



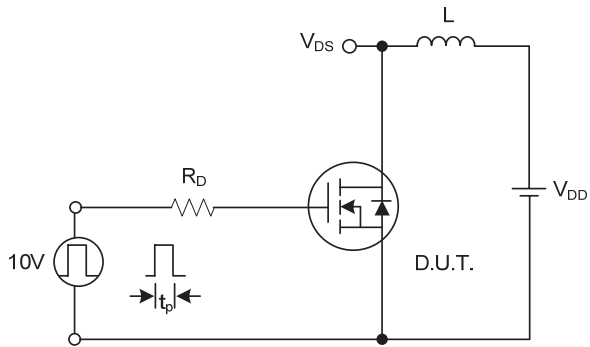
Switching Waveforms



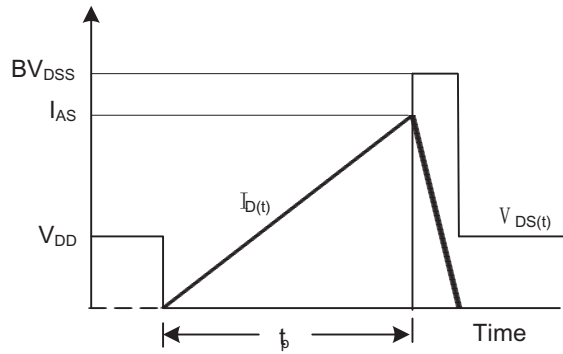
Gate Charge Test Circuit



Charge Gate Charge Waveform



Unclamped Inductive Switching Test Circuit

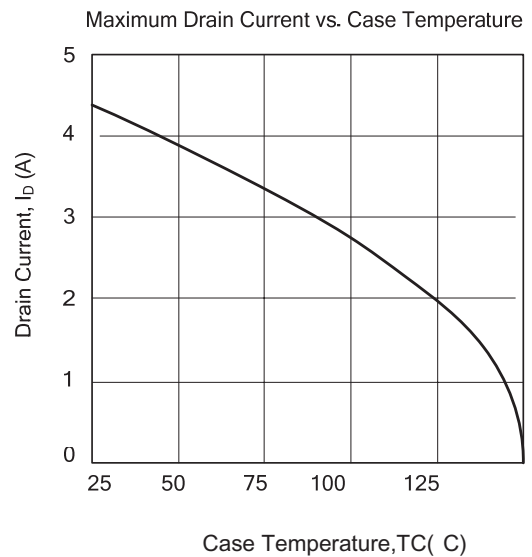
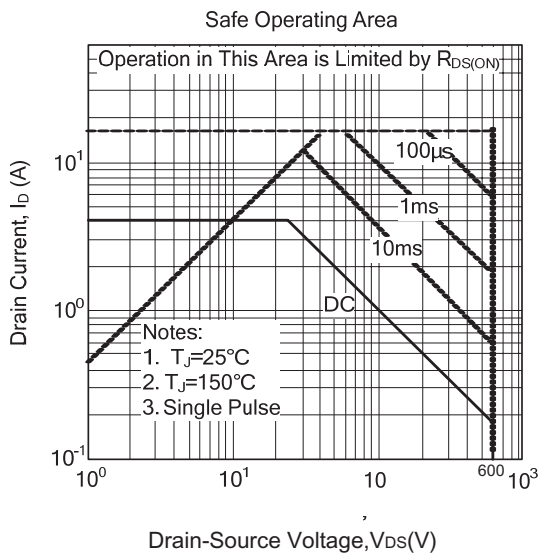
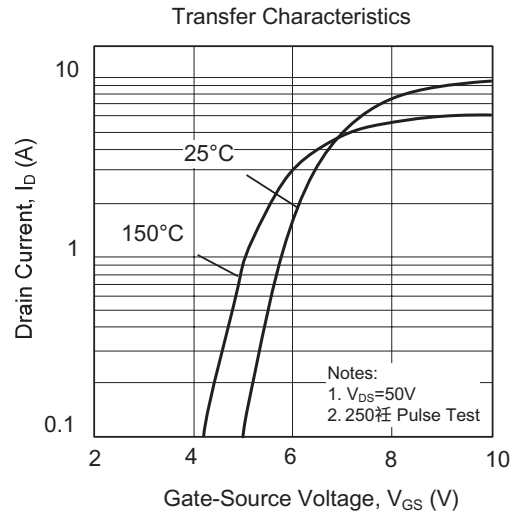
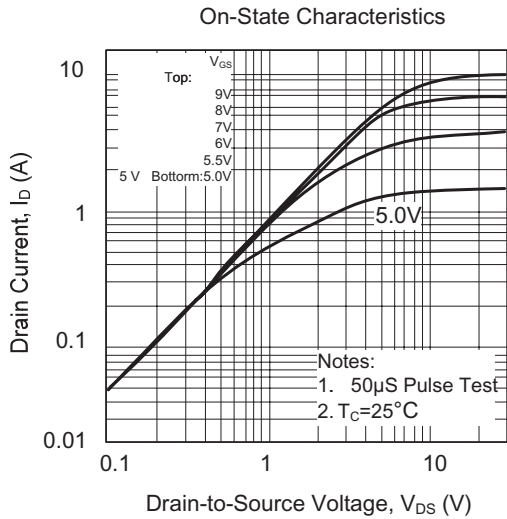
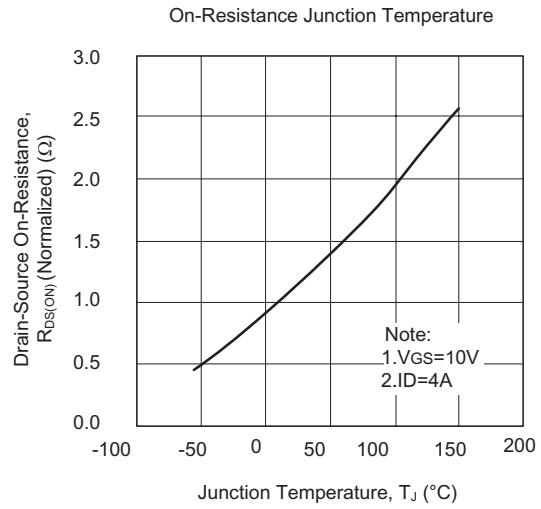
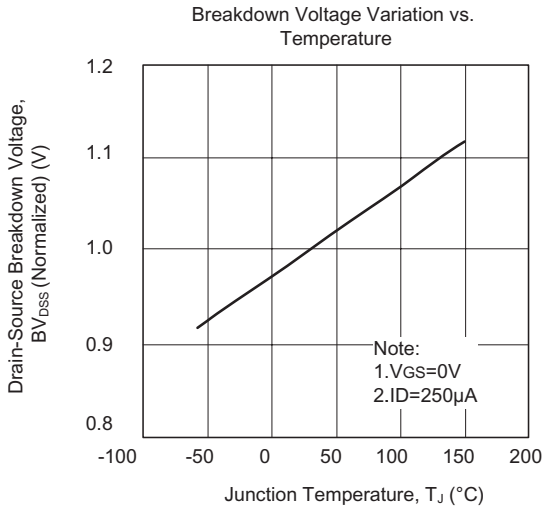


Unclamped Inductive Switching Waveforms

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650V N-Channel Power MOSFET

TYPICAL CHARACTERISTICS

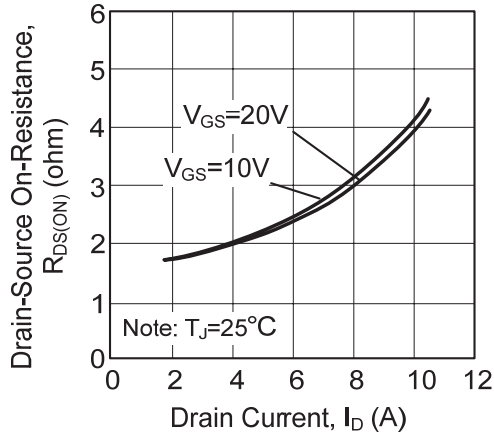


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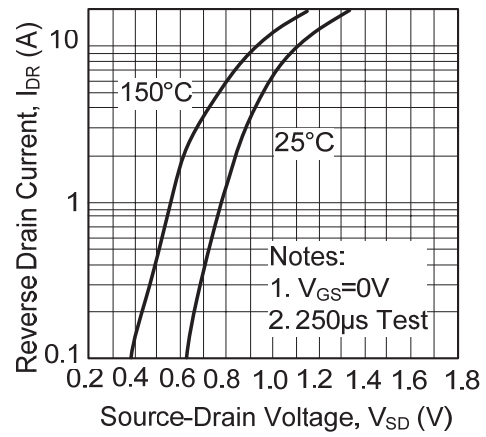
650V N-Channel Power MOSFET

TYPICAL CHARACTERISTICS

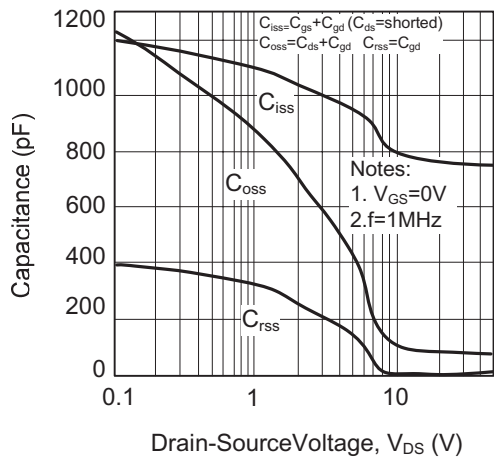
On-Resistance Variation vs. Drain Current and Gate Voltage



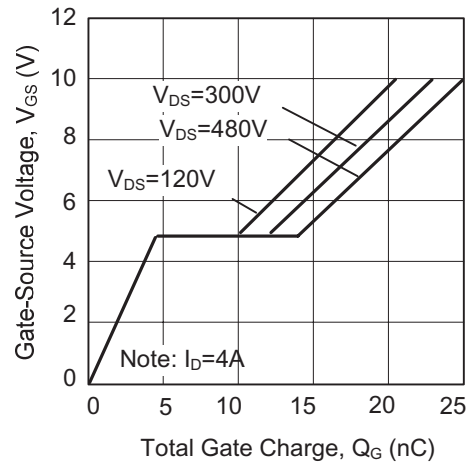
On State Current vs. Allowable Case Temperature



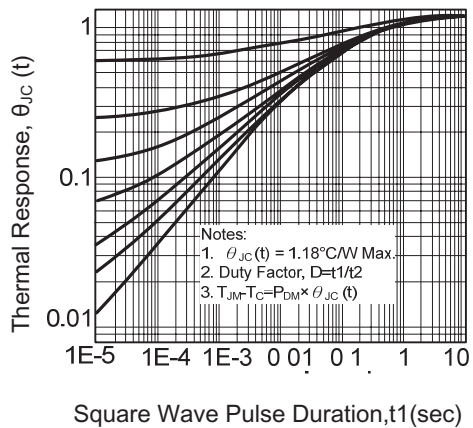
Capacitance Characteristics (Non-Repetitive)



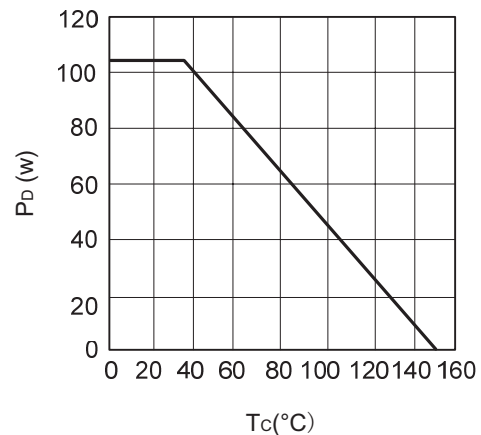
Gate Charge Characteristics



Transient Thermal Response Curve



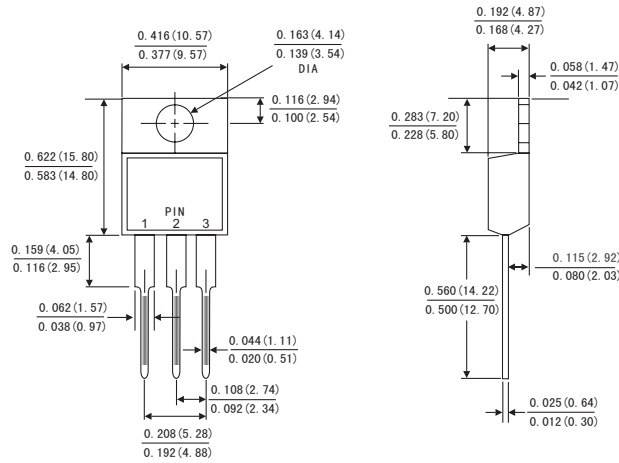
Power Dissipation



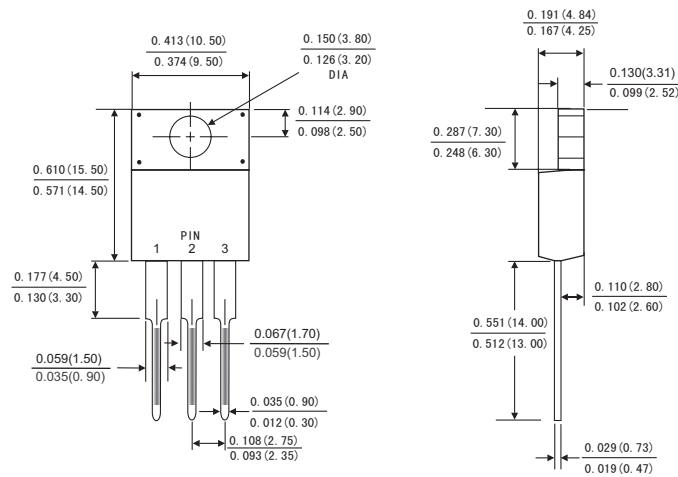
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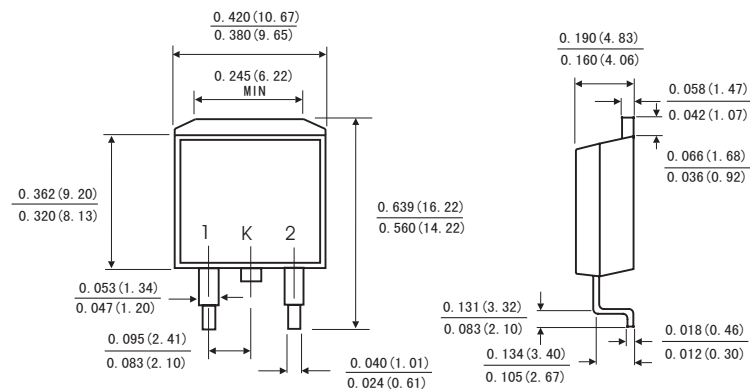
TO-220AB



ITO-220AB



TO-263



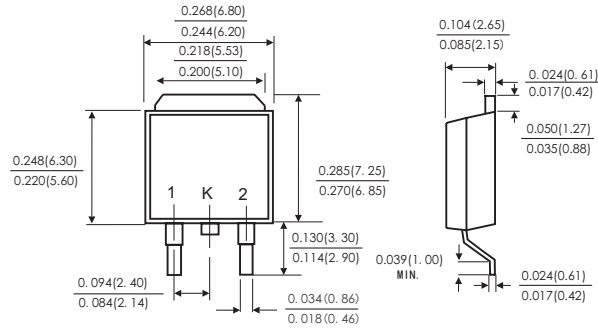
Dimensions in inches and (millimeters)

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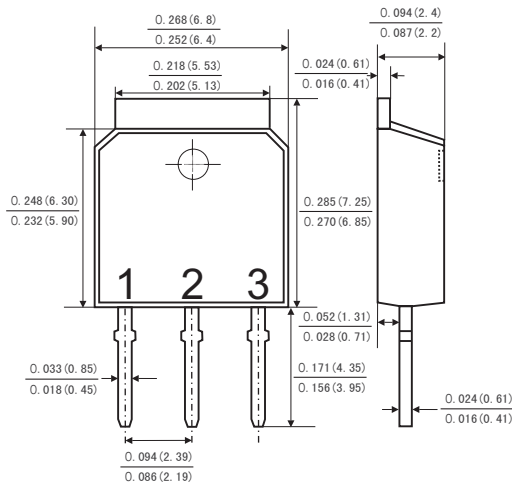
TO-252

(DPAK)



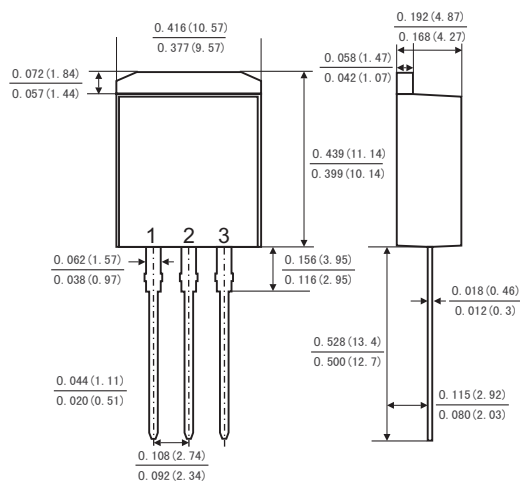
Dimensions in inches and (millimeters)

TO-251



Dimensions in inches and (millimeters)

TO-262



Dimensions in inches and (millimeters)